FP1007

High frequency, high current power inductors



Product description

- · High current carrying capacity
- · Low core loss
- Frequency range up to 2MHz
- Inductance Range from 115 nH to 300nH
- Current range from 32 to 94 amps
- 10.4 x 8.0mm footprint surface mount package in 6.5, 7.0 or 7.5mm height
- Ferrite core material
- Halogen free, lead free, RoHS compliant

Applications

- Servers
- · Multi-phase and Vcore regulators
- Voltage Regulator Modules (VRMs)
- Desktop VRMs and EVRDs
- Data networking and storage systems
- Graphics cards and battery power systems
- Point-of-Load modules
- · DCR Sensing circuits

Environmental data

- Storage temperature range (Component): -40°C to +125°C
- Operating temperature range: -40°C to +125°C (ambient + self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant









Product specifications

Part Number ⁷	OCL ¹ (nH)±10%	FLL ² (nH) minimum	I _{rms} ³ (amps)	I _{sat} 1 ⁴ (amps)	I _{sat} 2 ⁵ (amps)	DCR (mΩ) @ 20°C ±5%	K-factor ⁸
R1 version							
FP1007R1-R12-R	120	86	60	81	65	0.29 ± 10%	371
FP1007R1-R14-R	140	100	60	72	56	0.29 ± 10%	371
FP1007R1-R17-R	170	122	60	58	46	0.29 ± 10%	371
FP1007R1-R22-R	215	155	60	50	36	0.29 ± 10%	371
FP1007R1-R30-R	300	216	60	32	26	0.29 ± 10%	371
R2 version							
FP1007R2-R12-R	120	86	51	81	65	0.48 ± 8%	368
FP1007R2-R14-R	140	100	51	72	56	0.48 ± 8%	368
FP1007R2-R17-R	170	122	51	58	46	0.48 ± 8%	368
FP1007R2-R22-R	215	155	51	50	36	0.48 ± 8%	368
FP1007R2-R30-R	300	216	51	32	26	0.48 ± 8%	368
R3 version							
FP1007R3-R12-R	115	83	61	94	86	0.29 ± 5%	354
FP1007R3-R15-R	150	108	61	76	70	0.29 ± 5%	354
FP1007R3-R17-R	175	126	61	66	60	0.29 ± 5%	354
FP1007R3-R22-R	215	155	61	50	43	0.29 ± 5%	354
FP1007R3-R23-R	230	165	61	48	40	0.29 ± 5%	354
FP1007R3-R27-R	270	194	61	40	34	0.29 ± 5%	354
FP1007R3-R30-R	300	216	61	35	30	0.29 ± 5%	354

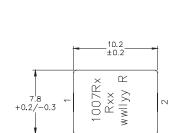
- 1. Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.1Vrms, 0.0Adc, +25°C
- 2. Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1Vrms, I_{sat}1, +25°C
- 3. I_{ms}: Irms: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.
- 4. I_{sat}1: Peak current for approximately 20% rolloff @ +25°C
- 5. I_{sat} 2: Peak current for approximately 20% rolloff @ +125°C

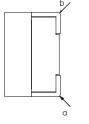
- 6. K-factor: Used to determine $B_{p,p}$ for core loss (see graph). $B_{p,p} = K * L * \Delta I * 10^3. B_{p,p}$ (Gauss), K: (K-factor from table), L: (Inductance in nH), ΔI (Peak-to-peak ripple current in Amps).
- 7. Part Number Definition: FP1007Rx-Rxx-R FP1007R= Product code and size
 - x = DCR indicator

 $Rxx = Inductance value in \mu H$, R = decimal point

-R suffix = RoHS compliant



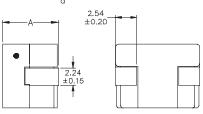




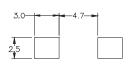
A FP1007R1= 6,80±0,2

FP1007R2= 6.30±0.2

FP1007R3= 7.30±0.2



Recommended Pad Layout





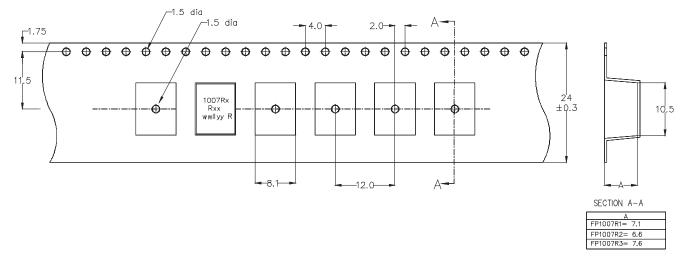


Part marking: 1007Rx (x = DCR indicator), Rxx (xx = inductance value in uH, R = decimal point, wwllyy = date code, R = revision level Tolerances are ± 0.25 millimeters unless stated otherwise. PCB tolerances are ± 0.1 millimeters unless stated otherwise All soldering surfaces to be coplanar within 0.1 millimeter DCR measured from point "a" to point "b" Do not route traces or vias underneath the inductor

Packaging information (mm)

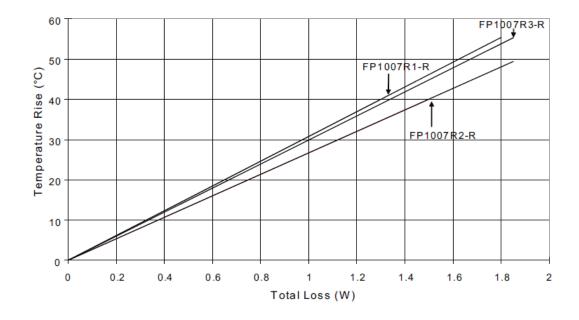
Supplied in tape and reel packaging, FP1007R1 700 parts per 13 " diameter reel FP1007R2 750 parts per 13 " diameter reel

FP1007R3 650 parts per 13 " diameter reel

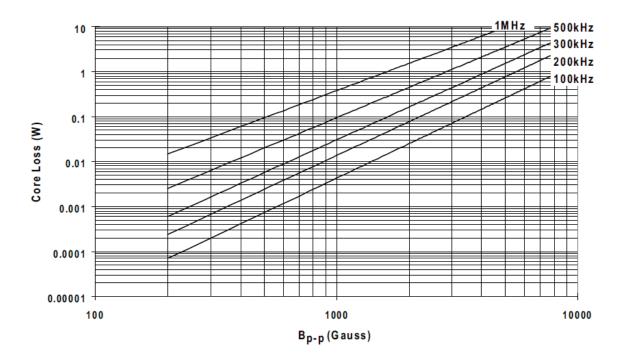


User direction of feed —

Temperature rise vs. total loss

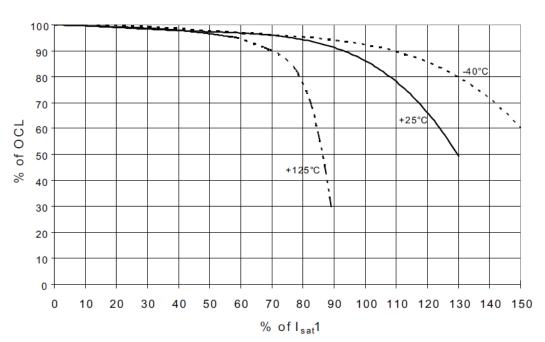


Core loss vs. B_{p-p}



Inductance characteristics





Solder reflow profile

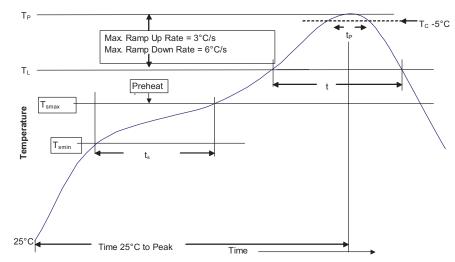


Table 1 - Standard SnPb Solder (T_C)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

older	
30 Seconds**	
8 Minutes Max.	

 $^{^{*}}$ Tolerance for peak profile temperature (T $_{\rm p}$) is defined as a supplier minimum and a user maximum.

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^{**} Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

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